# 2SK0065 (2SK65)

### Silicon N-Channel Junction FET

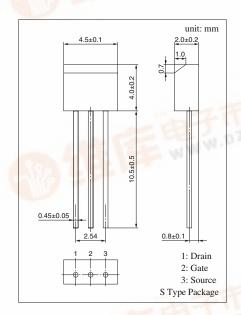
For impedance conversion in low frequency
For electret capacitor microphone

#### ■ Features

- Diode is connected between gate and source
- Low noise voltage

#### ■ Absolute Maximum Ratings (Ta = 25°C)

Parameter	Symbol	Ratings	Unit
Drain to Source voltage	V <sub>DSO</sub>	12	V
Gate to Drain voltage	V <sub>GDO</sub>	-12	V
Drain to Source current	$I_{DSO}$	2	mA
Drain to Gate current	$I_{DGO}$	2	mA
Gate to Source current	$I_{GSO}$	2	mA
Allowable power dissipation	$P_{\mathrm{D}}$	20	mW
Operating ambient temperature	T <sub>opr</sub>	-10 to +70	°C
Storage temperature	T <sub>stg</sub>	-20 to +150	°C

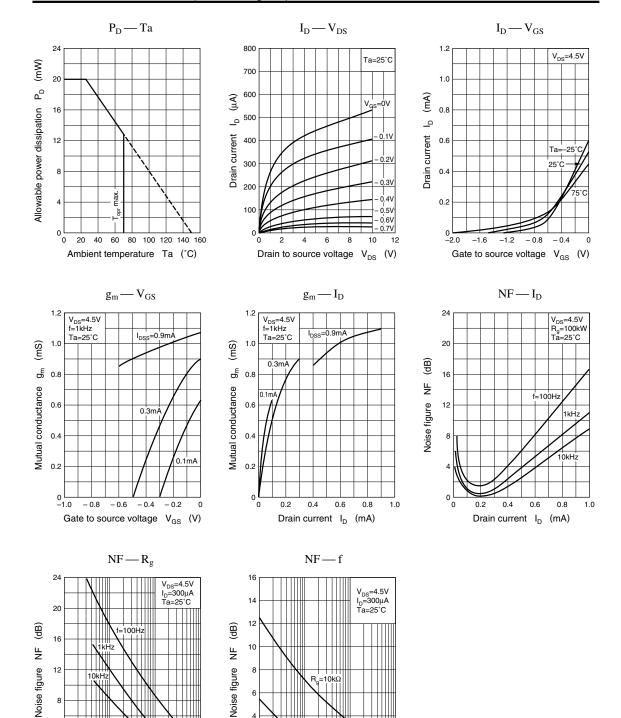


#### ■ Electrical Characteristics (Ta = 25°C)

Parameter	Symbol	Conditions	min	typ	max	Unit
Drain to Source cut-off current	I <sub>DSS</sub> *	$V_{DS} = 4.5V, V_{GS} = 0, R_S = 2.2k\Omega \pm 1\%$	0.04		0.8	mA
Mutual conductance	g <sub>m</sub>	$V_{DS} = 4.5V, V_{GS} = 0$	200	500		μS
		$R_S = 2.2k\Omega \pm 1\%$ , $f = 1kHz$	300			
Noise figure	NV	$V_{DS} = 4.5 \text{V}, R_S = 2.2 \text{k}\Omega \pm 1\%$			4	μV
		$C_G = 10pF$ , A-curve				
Voltage gain	G <sub>V1</sub> *	$V_{DS} = 4.5 \text{V}, R_S = 2.2 \text{k}\Omega \pm 1\%$		-10		dB
		$C_G = 10 \text{pF}, e_G = 100 \text{mV}, f = 70 \text{Hz}$				uБ
	G <sub>V2</sub> *	$V_{DS} = 12V, R_S = 2.2k\Omega \pm 1\%$	W(P)	-9.5		dB
		$C_G = 10 \text{pF}, e_G = 100 \text{mV}, f = 70 \text{Hz}$	-9.3			ub
	G <sub>V3</sub> *	$V_{DS} = 1V, R_S = 2.2k\Omega \pm 1\%$		1.1		ID
		$C_G = 10 \text{pF}, e_G = 100 \text{mV}, f = 70 \text{Hz}$	-11			dB

<sup>\*</sup> I<sub>DSS</sub> rank classification and G<sub>V</sub> value

Runk	P	Q				
I <sub>DSS</sub> (mA)	0.04 to 0.2	0.15 to 0.8				
$G_{V1}$ (dB)	>-13	>-12				
G <sub>V2</sub> (dB)	>-12	>-11				
$\Delta  G_{V1} - G_{V2}  (dB)$	< 3	< 3				



1000kΩ 0 0.01 0.03

0.1 0.3

Frequency f (KHz)

30

 $R_g$  (k $\Omega$ )

100

3 10

Signal source resistance

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